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Single P-Channel PowerTrench[®] MOSFET -12 V, -10 A, 16 m Ω

Features

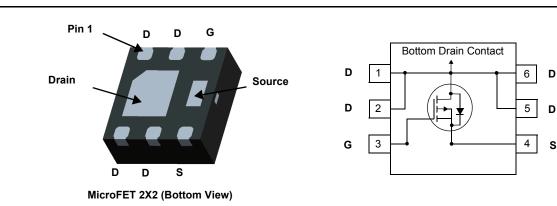
- Max r_{DS(on)} = 16 mΩ at V_{GS} = -4.5 V, I_D = -10 A
- Max r_{DS(on)} = 21 mΩ at V_{GS} = -2.5 V, I_D = -8.9 A
- Max $r_{DS(on)}$ = 82 m Ω at V_{GS} = -1.8 V, I_D = -4.5 A
- Low profile 0.8 mm maximum in the new package MicroFET 2X2 mm
- Free from halogenated compounds and antimony oxides
- RoHS Compliant



General Description

This device is designed specifically for battery charge or load switching in cellular handset and other ultraportable applications. It features a MOSFET with low on-state resistance.

The MicroFET 2X2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

| Symbol | Parameter | | Ratings | Units | |
|-----------------------------------|--|-----------|-------------|-------|--|
| V _{DS} | Drain to Source Voltage | | -12 | V | |
| V _{GS} | Gate to Source Voltage | | ±8 | V | |
| 1 | Drain Current -Continuous | (Note 1a) | -10 | • | |
| D | -Pulsed | | -40 | Α | |
| D | Power Dissipation | (Note 1a) | 2.4 | w | |
| PD | Power Dissipation | (Note 1b) | 0.9 | | |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | | -55 to +150 | °C | |

Thermal Characteristics

| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | | 6.9 | |
|---------------------|---|-------|-----|------|
| $R_{	ext{	heta}JA}$ | Thermal Resistance, Junction to Ambient (Note | e 1a) | 52 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient (Note | e 1b) | 145 | |

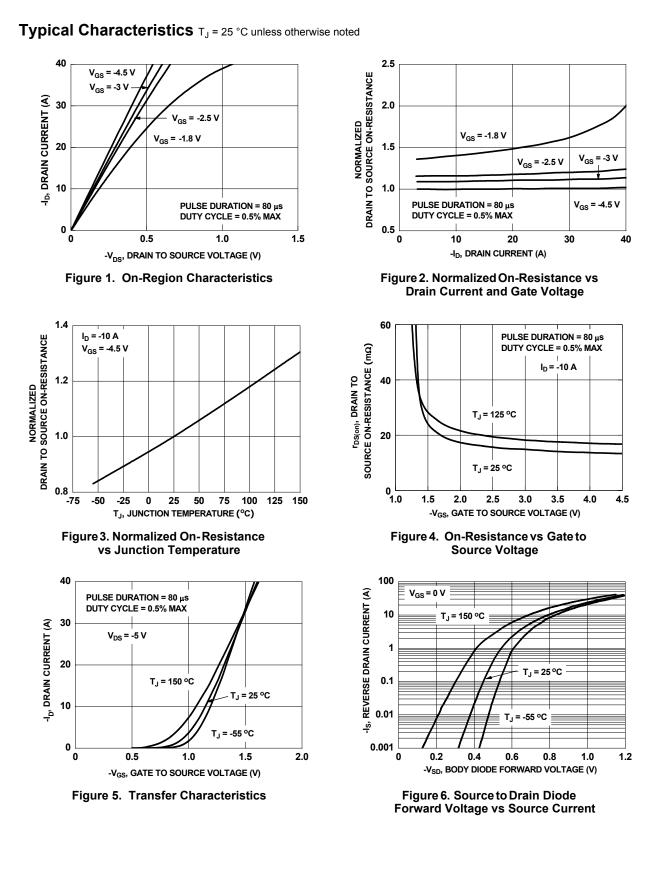
Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|----------|--------------|-----------|------------|------------|
| A95 | FDMA905P | MicroFET 2X2 | 7 " | 8 mm | 3000 units |

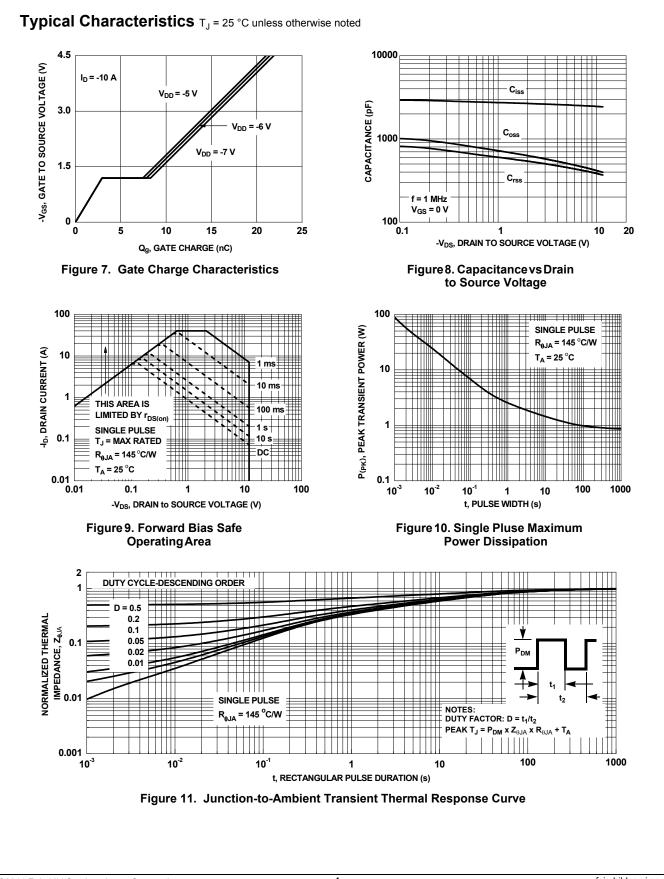
June 2014

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Units |
|--|--|---|--------------|----------------|-------|--------------|
| Off Chara | octeristics | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | I _D = -250 μA, V _{GS} = 0V | -12 | | | V |
| ΔBV _{DSS} ΔTJ | Breakdown Voltage Temperature | $I_D = -250 \ \mu$ A, referenced to 25 °C | | -4.3 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = -9.6 V, V _{GS} = 0 V | | | -1 | μA |
| I _{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 8 V, V_{DS} = 0 V$ | | | ±100 | nA |
| | cteristics | | | • • | | |
| | | | -0.4 | 0.7 | 1.0 | V |
| V _{GS(th)} | Gate to Source Threshold Voltage Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_D = -250 \ \mu A$ | -0.4 | -0.7 | -1.0 | v |
| $rac{\Delta V_{GS(th)}}{\Delta T_J}$ | Temperature Coefficient | I_D = -250 μ A, referenced to 25 °C | | 2.6 | | mV/°C |
| | | V _{GS} = -4.5 V, I _D = -10 A | | 14 | 16 | |
| - | Statia Drain ta Sauraa On Dagiatanga | V _{GS} = -2.5 V, I _D = -8.9 A | | 17 | 21 | |
| r _{DS(on)} | Static Drain to Source On Resistance | V _{GS} = -1.8 V, I _D = -4.5 A | | 21 | 82 | mΩ |
| | | V _{GS} = -4.5 V, I _D = -10 A, T _J = 125 °C | | 16 | 21 | 1 |
| 9 _{FS} | Forward Transconductance | V _{DD} = -5 V, I _D = -10 A | | 50 | | S |
| Dvnamic | Characteristics | | | | | |
| C _{iss} | Input Capacitance | | | 2559 | 3405 | pF |
| C _{oss} | Output Capacitance | V _{DS} = -6 V, V _{GS} = 0 V, | | 490 | 735 | pF |
| C _{rss} | Reverse Transfer Capacitance | f = 1 MHz | | 437 | 655 | pF |
| | | | | | | р. |
| Switching | Characteristics | 1 | | | | |
| t _{d(on)} | Turn-On Delay Time | _ | | 11 | 20 | ns |
| t _r | Rise Time | V _{DD} = -6 V, I _D = -10 A, | | 11 | 20 | ns |
| t _{d(off)} | Turn-Off Delay Time | V_{GS} = -4.5 V, R_{GEN} = 6 Ω | | 120 | 192 | ns |
| t _f | Fall Time | | | 59 | 94 | ns |
| Qg | Total Gate Charge | – V _{DD} = -6 V, I _D = -10 A, | | 21 | 29 | nC |
| Q _{gs} | Gate to Source Charge | $V_{GS} = -4.5 V$ | | 3.5 | | nC |
| Q _{gd} | Gate to Drain "Miller" Charge | | | 4.2 | | nC |
| Drain-Sou | urce Diode Characteristics | | | | | |
| . , | | $V_{GS} = 0 V, I_S = -2 A$ (Note 2) | | -0.6 | -1.2 | |
| V _{SD} | Source to Drain Diode Forward Voltage | $V_{GS} = 0 V, I_S = -10 A$ (Note 2) | | -0.8 | -1.2 | V |
| t _{rr} | Reverse Recovery Time | | | 21 | 34 | ns |
| Q _{rr} | Reverse Recovery Charge | –I _F = -10 A, di/dt = 100 A/μs | | 6.1 | 12 | nC |
| lotes: . R _{θJA} is determ the user's boz | nined with the device mounted on a 1 in ² pad 2 oz copper p rrd design. a. 52 °C/W when mo a 1 in ² pad of 2 oz | unted on b | . 145 °C/W v | by design whil | ion a | etermined by |
| 2. Pulse Test: Pi | ulse Width < 300 μ s, Duty cycle < 2.0 %. | | | | | |
| | | | | | | |
| • | | | | | | |

FDMA905P Single P-Channel PowerTrench[®] MOSFET



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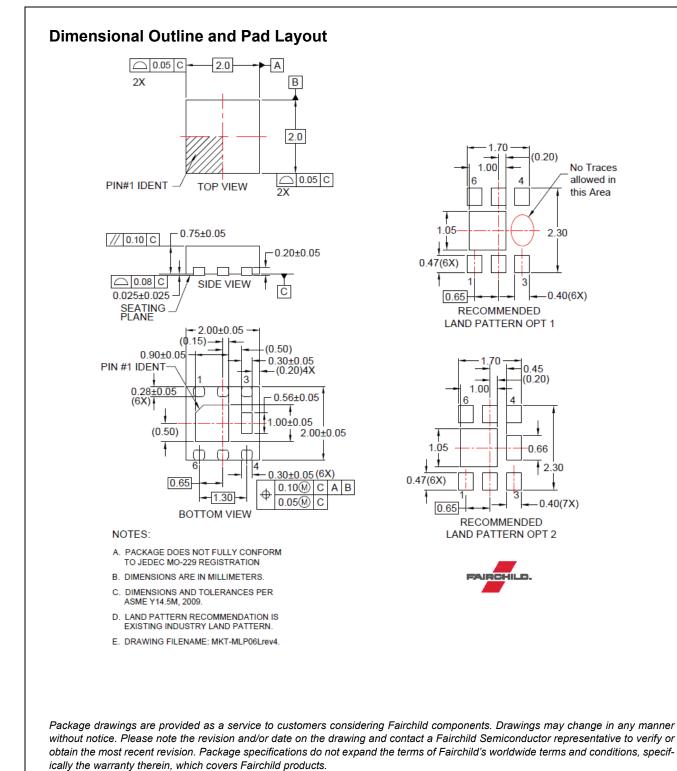
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